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### Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	12 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	32
Number of Macrocells	512
Number of Gates	10000
Number of I/O	120
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/epm7512aetc144-12">https://www.e-xfl.com/product-detail/intel/epm7512aetc144-12</a>

MAX 7000A devices use CMOS EEPROM cells to implement logic functions. The user-configurable MAX 7000A architecture accommodates a variety of independent combinatorial and sequential logic functions. The devices can be reprogrammed for quick and efficient iterations during design development and debug cycles, and can be programmed and erased up to 100 times.

MAX 7000A devices contain from 32 to 512 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND/fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms, providing up to 32 product terms per macrocell.

MAX 7000A devices provide programmable speed/power optimization. Speed-critical portions of a design can run at high speed/full power, while the remaining portions run at reduced speed/low power. This speed/power optimization feature enables the designer to configure one or more macrocells to operate at 50% or lower power while adding only a nominal timing delay. MAX 7000A devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. The output drivers of all MAX 7000A devices can be set for 2.5 V or 3.3 V, and all input pins are 2.5-V, 3.3-V, and 5.0-V tolerant, allowing MAX 7000A devices to be used in mixed-voltage systems.

MAX 7000A devices are supported by Altera development systems, which are integrated packages that offer schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The software provides EDIF 2.0 and 3.0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The software runs on Windows-based PCs, as well as Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information on development tools, see the [MAX+PLUS II Programmable Logic Development System & Software Data Sheet](#) and the [Quartus Programmable Logic Development System & Software Data Sheet](#).

## Expander Product Terms

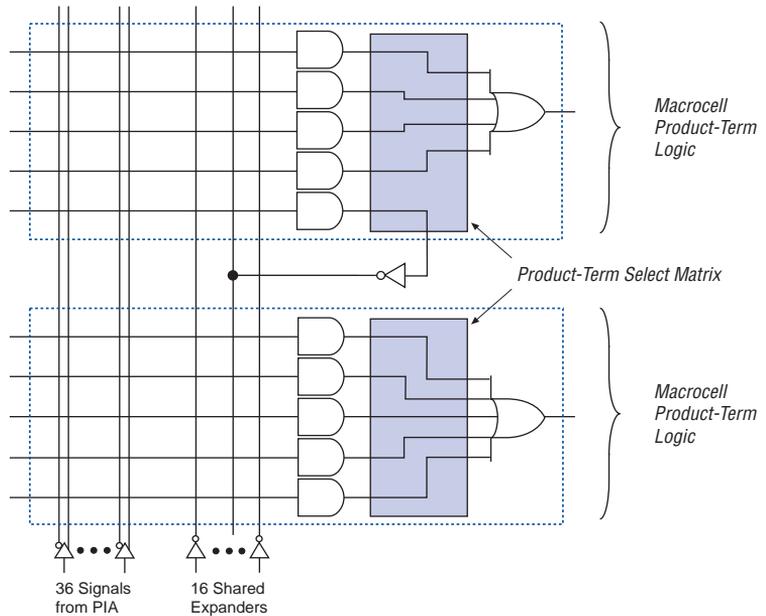
Although most logic functions can be implemented with the five product terms available in each macrocell, more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources. However, the MAX 7000A architecture also offers both shareable and parallel expander product terms that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

### Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay ( $t_{SEXP}$ ) is incurred when shareable expanders are used. Figure 3 shows how shareable expanders can feed multiple macrocells.

**Figure 3. MAX 7000A Shareable Expanders**

Shareable expanders can be shared by any or all macrocells in an LAB.



## Programming Times

The time required to implement each of the six programming stages can be broken into the following two elements:

- A pulse time to erase, program, or read the EEPROM cells.
- A shifting time based on the test clock (TCK) frequency and the number of TCK cycles to shift instructions, address, and data into the device.

By combining the pulse and shift times for each of the programming stages, the program or verify time can be derived as a function of the TCK frequency, the number of devices, and specific target device(s). Because different ISP-capable devices have a different number of EEPROM cells, both the total fixed and total variable times are unique for a single device.

### *Programming a Single MAX 7000A Device*

The time required to program a single MAX 7000A device in-system can be calculated from the following formula:

$$t_{PROG} = t_{PPULSE} + \frac{Cycle_{PTCK}}{f_{TCK}}$$

where:  $t_{PROG}$  = Programming time  
 $t_{PPULSE}$  = Sum of the fixed times to erase, program, and verify the EEPROM cells  
 $Cycle_{PTCK}$  = Number of TCK cycles to program a device  
 $f_{TCK}$  = TCK frequency

The ISP times for a stand-alone verification of a single MAX 7000A device can be calculated from the following formula:

$$t_{VER} = t_{VPULSE} + \frac{Cycle_{VTCK}}{f_{TCK}}$$

where:  $t_{VER}$  = Verify time  
 $t_{VPULSE}$  = Sum of the fixed times to verify the EEPROM cells  
 $Cycle_{VTCK}$  = Number of TCK cycles to verify a device

The programming times described in Tables 5 through 7 are associated with the worst-case method using the enhanced ISP algorithm.

**Table 5. MAX 7000A  $t_{PULSE}$  &  $Cycle_{TCK}$  Values**

Device	Programming		Stand-Alone Verification	
	$t_{PPULSE}$ (s)	$Cycle_{PTCK}$	$t_{VPULSE}$ (s)	$Cycle_{VTCK}$
EPM7032AE	2.00	55,000	0.002	18,000
EPM7064AE	2.00	105,000	0.002	35,000
EPM7128AE	2.00	205,000	0.002	68,000
EPM7256AE	2.00	447,000	0.002	149,000
EPM7512AE	2.00	890,000	0.002	297,000
EPM7128A (1)	5.11	832,000	0.03	528,000
EPM7256A (1)	6.43	1,603,000	0.03	1,024,000

Tables 6 and 7 show the in-system programming and stand alone verification times for several common test clock frequencies.

**Table 6. MAX 7000A In-System Programming Times for Different Test Clock Frequencies**

Device	$f_{TCK}$								Units
	10 MHz	5 MHz	2 MHz	1 MHz	500 kHz	200 kHz	100 kHz	50 kHz	
EPM7032AE	2.01	2.01	2.03	2.06	2.11	2.28	2.55	3.10	s
EPM7064AE	2.01	2.02	2.05	2.11	2.21	2.53	3.05	4.10	s
EPM7128AE	2.02	2.04	2.10	2.21	2.41	3.03	4.05	6.10	s
EPM7256AE	2.05	2.09	2.23	2.45	2.90	4.24	6.47	10.94	s
EPM7512AE	2.09	2.18	2.45	2.89	3.78	6.45	10.90	19.80	s
EPM7128A (1)	5.19	5.27	5.52	5.94	6.77	9.27	13.43	21.75	s
EPM7256A (1)	6.59	6.75	7.23	8.03	9.64	14.45	22.46	38.49	s

**Table 7. MAX 7000A Stand-Alone Verification Times for Different Test Clock Frequencies**

Device	$f_{TCK}$								Units
	10 MHz	5 MHz	2 MHz	1 MHz	500 kHz	200 kHz	100 kHz	50 kHz	
EPM7032AE	0.00	0.01	0.01	0.02	0.04	0.09	0.18	0.36	s
EPM7064AE	0.01	0.01	0.02	0.04	0.07	0.18	0.35	0.70	s
EPM7128AE	0.01	0.02	0.04	0.07	0.14	0.34	0.68	1.36	s
EPM7256AE	0.02	0.03	0.08	0.15	0.30	0.75	1.49	2.98	s
EPM7512AE	0.03	0.06	0.15	0.30	0.60	1.49	2.97	5.94	s
EPM7128A (1)	0.08	0.14	0.29	0.56	1.09	2.67	5.31	10.59	s
EPM7256A (1)	0.13	0.24	0.54	1.06	2.08	5.15	10.27	20.51	s

**Note to tables:**

- (1) EPM7128A and EPM7256A devices can only be programmed with an adaptive algorithm; users programming these two devices on platforms that cannot use an adaptive algorithm should use EPM7128AE and EPM7256AE devices.

## Programming with External Hardware



MAX 7000A devices can be programmed on Windows-based PCs with an Altera Logic Programmer card, the MPU, and the appropriate device adapter. The MPU performs continuity checks to ensure adequate electrical contact between the adapter and the device.

For more information, see the [Altera Programming Hardware Data Sheet](#).

The Altera software can use text- or waveform-format test vectors created with the Altera Text Editor or Waveform Editor to test the programmed device. For added design verification, designers can perform functional testing to compare the functional device behavior with the results of simulation.

Data I/O, BP Microsystems, and other programming hardware manufacturers provide programming support for Altera devices.



For more information, see [Programming Hardware Manufacturers](#).

## IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

MAX 7000A devices include the JTAG BST circuitry defined by IEEE Std. 1149.1. [Table 8](#) describes the JTAG instructions supported by MAX 7000A devices. The pin-out tables, available from the Altera web site (<http://www.altera.com>), show the location of the JTAG control pins for each device. If the JTAG interface is not required, the JTAG pins are available as user I/O pins.

## Programmable Speed/Power Control

MAX 7000A devices offer a power-saving mode that supports low-power operation across user-defined signal paths or the entire device. This feature allows total power dissipation to be reduced by 50% or more because most logic applications require only a small fraction of all gates to operate at maximum frequency.

The designer can program each individual macrocell in a MAX 7000A device for either high-speed (i.e., with the Turbo Bit™ option turned on) or low-power operation (i.e., with the Turbo Bit option turned off). As a result, speed-critical paths in the design can run at high speed, while the remaining paths can operate at reduced power. Macrocells that run at low power incur a nominal timing delay adder ( $t_{LPA}$ ) for the  $t_{LAD}$ ,  $t_{LAC}$ ,  $t_{IC}$ ,  $t_{EN}$ ,  $t_{SEXP}$ ,  $t_{ACL}$ , and  $t_{CPPW}$  parameters.

## Output Configuration

MAX 7000A device outputs can be programmed to meet a variety of system-level requirements.

### MultiVolt I/O Interface

The MAX 7000A device architecture supports the MultiVolt I/O interface feature, which allows MAX 7000A devices to connect to systems with differing supply voltages. MAX 7000A devices in all packages can be set for 2.5-V, 3.3-V, or 5.0-V I/O pin operation. These devices have one set of VCC pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCIO pins can be connected to either a 3.3-V or 2.5-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with VCCIO levels lower than 3.0 V incur a slightly greater timing delay of  $t_{OD2}$  instead of  $t_{OD1}$ . Inputs can always be driven by 2.5-V, 3.3-V, or 5.0-V signals.

Table 12 describes the MAX 7000A MultiVolt I/O support.

V <sub>CCIO</sub> Voltage	Input Signal (V)			Output Signal (V)		
	2.5	3.3	5.0	2.5	3.3	5.0
2.5	✓	✓	✓	✓		
3.3	✓	✓	✓		✓	✓

## Power Sequencing & Hot-Socketing

Because MAX 7000A devices can be used in a mixed-voltage environment, they have been designed specifically to tolerate any possible power-up sequence. The  $V_{CCIO}$  and  $V_{CCINT}$  power planes can be powered in any order.

Signals can be driven into MAX 7000AE devices before and during power-up (and power-down) without damaging the device. Additionally, MAX 7000AE devices do not drive out during power-up. Once operating conditions are reached, MAX 7000AE devices operate as specified by the user.

MAX 7000AE device I/O pins will not source or sink more than 300  $\mu$ A of DC current during power-up. All pins can be driven up to 5.75 V during hot-socketing, except the  $OE1$  and  $GLCRn$  pins. The  $OE1$  and  $GLCRn$  pins can be driven up to 3.6 V during hot-socketing. After  $V_{CCINT}$  and  $V_{CCIO}$  reach the recommended operating conditions, these two pins are 5.0-V tolerant.

EPM7128A and EPM7256A devices do not support hot-socketing and may drive out during power-up.

## Design Security

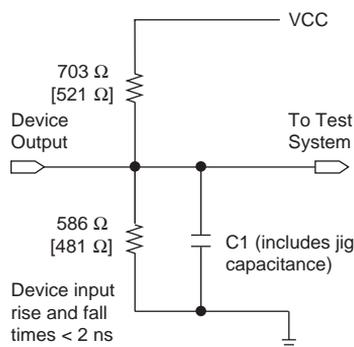
All MAX 7000A devices contain a programmable security bit that controls access to the data programmed into the device. When this bit is programmed, a design implemented in the device cannot be copied or retrieved. This feature provides a high level of design security because programmed data within EEPROM cells is invisible. The security bit that controls this function, as well as all other programmed data, is reset only when the device is reprogrammed.

## Generic Testing

MAX 7000A devices are fully tested. Complete testing of each programmable EEPROM bit and all internal logic elements ensures 100% programming yield. AC test measurements are taken under conditions equivalent to those shown in [Figure 9](#). Test patterns can be used and then erased during early stages of the production flow.

**Figure 9. MAX 7000A AC Test Conditions**

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in brackets are for 2.5-V outputs. Numbers without brackets are for 3.3-V outputs.



## Operating Conditions

Tables 13 through 16 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for MAX 7000A devices.

**Table 13. MAX 7000A Device Absolute Maximum Ratings** *Note (1)*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	Supply voltage	With respect to ground (2)	-0.5	4.6	V
$V_I$	DC input voltage		-2.0	5.75	V
$I_{OUT}$	DC output current, per pin		-25	25	mA
$T_{STG}$	Storage temperature	No bias	-65	150	°C
$T_A$	Ambient temperature	Under bias	-65	135	°C
$T_J$	Junction temperature	BGA, FineLine BGA, PQFP, and TQFP packages, under bias		135	°C

**Table 14. MAX 7000A Device Recommended Operating Conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CCINT</sub>	Supply voltage for internal logic and input buffers	(3), (13)	3.0	3.6	V
V <sub>CCIO</sub>	Supply voltage for output drivers, 3.3-V operation	(3)	3.0	3.6	V
	Supply voltage for output drivers, 2.5-V operation	(3)	2.3	2.7	V
V <sub>CCISP</sub>	Supply voltage during in-system programming		3.0	3.6	V
V <sub>I</sub>	Input voltage	(4)	-0.5	5.75	V
V <sub>O</sub>	Output voltage		0	V <sub>CCIO</sub>	V
T <sub>A</sub>	Ambient temperature	Commercial range	0	70	°C
		Industrial range (5)	-40	85	°C
T <sub>J</sub>	Junction temperature	Commercial range	0	90	°C
		Industrial range (5)	-40	105	°C
		Extended range (5)	-40	130	°C
t <sub>R</sub>	Input rise time			40	ns
t <sub>F</sub>	Input fall time			40	ns

**Table 18. EPM7032AE Internal Timing Parameters (Part 2 of 2)** *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-4		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{IC}$	Array clock delay			1.2		2.0		2.5	ns
$t_{EN}$	Register enable time			0.6		1.0		1.2	ns
$t_{GLOB}$	Global control delay			0.8		1.3		1.9	ns
$t_{PRE}$	Register preset time			1.2		1.9		2.6	ns
$t_{CLR}$	Register clear time			1.2		1.9		2.6	ns
$t_{PIA}$	PIA delay	(2)		0.9		1.5		2.1	ns
$t_{LPA}$	Low-power adder	(6)		2.5		4.0		5.0	ns

Table 20. EPM7064AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-4		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{IN}$	Input pad and buffer delay			0.6		1.1		1.4	ns
$t_{IO}$	I/O input pad and buffer delay			0.6		1.1		1.4	ns
$t_{FIN}$	Fast input delay			2.5		3.0		3.7	ns
$t_{SEXP}$	Shared expander delay			1.8		3.0		3.9	ns
$t_{PEXP}$	Parallel expander delay			0.4		0.7		0.9	ns
$t_{LAD}$	Logic array delay			1.5		2.5		3.2	ns
$t_{LAC}$	Logic control array delay			0.6		1.0		1.2	ns
$t_{IOE}$	Internal output enable delay			0.0		0.0		0.0	ns
$t_{OD1}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		0.8		1.3		1.8	ns
$t_{OD2}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		1.3		1.8		2.3	ns
$t_{OD3}$	Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or $3.3\text{ V}$	$C1 = 35\text{ pF}$		5.8		6.3		6.8	ns
$t_{ZX1}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		4.0		4.0		5.0	ns
$t_{ZX2}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		4.5		4.5		5.5	ns
$t_{ZX3}$	Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		9.0		9.0		10.0	ns
$t_{XZ}$	Output buffer disable delay	$C1 = 5\text{ pF}$		4.0		4.0		5.0	ns
$t_{SU}$	Register setup time		1.3		2.0		2.9		ns
$t_H$	Register hold time		0.6		1.0		1.3		ns
$t_{FSU}$	Register setup time of fast input		1.0		1.5		1.5		ns
$t_{FH}$	Register hold time of fast input		1.5		1.5		1.5		ns
$t_{RD}$	Register delay			0.7		1.2		1.6	ns
$t_{COMB}$	Combinatorial delay			0.6		0.9		1.3	ns
$t_{IC}$	Array clock delay			1.2		1.9		2.5	ns

Table 20. EPM7064AE Internal Timing Parameters (Part 2 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-4		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{EN}$	Register enable time			0.6		1.0		1.2	ns
$t_{GLOB}$	Global control delay			1.0		1.5		2.2	ns
$t_{PRE}$	Register preset time			1.3		2.1		2.9	ns
$t_{CLR}$	Register clear time			1.3		2.1		2.9	ns
$t_{PIA}$	PIA delay	(2)		1.0		1.7		2.3	ns
$t_{LPA}$	Low-power adder	(6)		3.5		4.0		5.0	ns

Table 22. EPM7128AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-5		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{IN}$	Input pad and buffer delay			0.7		1.0		1.4	ns
$t_{IO}$	I/O input pad and buffer delay			0.7		1.0		1.4	ns
$t_{FIN}$	Fast input delay			2.5		3.0		3.4	ns
$t_{SEXP}$	Shared expander delay			2.0		2.9		3.8	ns
$t_{PEXP}$	Parallel expander delay			0.4		0.7		0.9	ns
$t_{LAD}$	Logic array delay			1.6		2.4		3.1	ns
$t_{LAC}$	Logic control array delay			0.7		1.0		1.3	ns
$t_{IOE}$	Internal output enable delay			0.0		0.0		0.0	ns
$t_{OD1}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		0.8		1.2		1.6	ns
$t_{OD2}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		1.3		1.7		2.1	ns
$t_{OD3}$	Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or $3.3\text{ V}$	$C1 = 35\text{ pF}$		5.8		6.2		6.6	ns
$t_{ZX1}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		4.0		4.0		5.0	ns
$t_{ZX2}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		4.5		4.5		5.5	ns
$t_{ZX3}$	Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		9.0		9.0		10.0	ns
$t_{XZ}$	Output buffer disable delay	$C1 = 5\text{ pF}$		4.0		4.0		5.0	ns
$t_{SU}$	Register setup time		1.4		2.1		2.9		ns
$t_H$	Register hold time		0.6		1.0		1.3		ns
$t_{FSU}$	Register setup time of fast input		1.1		1.6		1.6		ns
$t_{FH}$	Register hold time of fast input		1.4		1.4		1.4		ns
$t_{RD}$	Register delay			0.8		1.2		1.6	ns
$t_{COMB}$	Combinatorial delay			0.5		0.9		1.3	ns
$t_{IC}$	Array clock delay			1.2		1.7		2.2	ns

Table 24. EPM7256AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-5		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{IN}$	Input pad and buffer delay			0.7		0.9		1.2	ns
$t_{IO}$	I/O input pad and buffer delay			0.7		0.9		1.2	ns
$t_{FIN}$	Fast input delay			2.4		2.9		3.4	ns
$t_{SEXP}$	Shared expander delay			2.1		2.8		3.7	ns
$t_{PEXP}$	Parallel expander delay			0.3		0.5		0.6	ns
$t_{LAD}$	Logic array delay			1.7		2.2		2.8	ns
$t_{LAC}$	Logic control array delay			0.8		1.0		1.3	ns
$t_{IOE}$	Internal output enable delay			0.0		0.0		0.0	ns
$t_{OD1}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		0.9		1.2		1.6	ns
$t_{OD2}$	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		1.4		1.7		2.1	ns
$t_{OD3}$	Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or $3.3\text{ V}$	$C1 = 35\text{ pF}$		5.9		6.2		6.6	ns
$t_{ZX1}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		4.0		4.0		5.0	ns
$t_{ZX2}$	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$	$C1 = 35\text{ pF}$ (5)		4.5		4.5		5.5	ns
$t_{ZX3}$	Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$	$C1 = 35\text{ pF}$		9.0		9.0		10.0	ns
$t_{XZ}$	Output buffer disable delay	$C1 = 5\text{ pF}$		4.0		4.0		5.0	ns
$t_{SU}$	Register setup time		1.5		2.1		2.9		ns
$t_H$	Register hold time		0.7		0.9		1.2		ns
$t_{FSU}$	Register setup time of fast input		1.1		1.6		1.6		ns
$t_{FH}$	Register hold time of fast input		1.4		1.4		1.4		ns
$t_{RD}$	Register delay			0.9		1.2		1.6	ns
$t_{COMB}$	Combinatorial delay			0.5		0.8		1.2	ns

Table 24. EPM7256AE Internal Timing Parameters (Part 2 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade						Unit
			-5		-7		-10		
			Min	Max	Min	Max	Min	Max	
$t_{IC}$	Array clock delay			1.2		1.6		2.1	ns
$t_{EN}$	Register enable time			0.8		1.0		1.3	ns
$t_{GLOB}$	Global control delay			1.0		1.5		2.0	ns
$t_{PRE}$	Register preset time			1.6		2.3		3.0	ns
$t_{CLR}$	Register clear time			1.6		2.3		3.0	ns
$t_{PIA}$	PIA delay	(2)		1.7		2.4		3.2	ns
$t_{LPA}$	Low-power adder	(6)		4.0		4.0		5.0	ns

Table 27. EPM7128A External Timing Parameters *Note (1)*

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	
$t_{PD1}$	Input to non-registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns
$t_{PD2}$	I/O input to non-registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns
$t_{SU}$	Global clock setup time	(2)	4.2		5.3		7.0		8.5		ns
$t_{H}$	Global clock hold time	(2)	0.0		0.0		0.0		0.0		ns
$t_{FSU}$	Global clock setup time of fast input		2.5		3.0		3.0		3.0		ns
$t_{FH}$	Global clock hold time of fast input		0.0		0.0		0.0		0.0		ns
$t_{CO1}$	Global clock to output delay	C1 = 35 pF	1.0	3.7	1.0	4.6	1.0	6.1	1.0	7.3	ns
$t_{CH}$	Global clock high time		3.0		3.0		4.0		5.0		ns
$t_{CL}$	Global clock low time		3.0		3.0		4.0		5.0		ns
$t_{ASU}$	Array clock setup time	(2)	1.9		2.4		3.1		3.8		ns
$t_{AH}$	Array clock hold time	(2)	1.5		2.2		3.3		4.3		ns
$t_{ACO1}$	Array clock to output delay	C1 = 35 pF (2)	1.0	6.0	1.0	7.5	1.0	10.0	1.0	12.0	ns
$t_{ACH}$	Array clock high time		3.0		3.0		4.0		5.0		ns
$t_{ACL}$	Array clock low time		3.0		3.0		4.0		5.0		ns
$t_{CPPW}$	Minimum pulse width for clear and preset	(3)	3.0		3.0		4.0		5.0		ns
$t_{CNT}$	Minimum global clock period	(2)		6.9		8.6		11.5		13.8	ns
$f_{CNT}$	Maximum internal global clock frequency	(2), (4)	144.9		116.3		87.0		72.5		MHz
$t_{ACNT}$	Minimum array clock period	(2)		6.9		8.6		11.5		13.8	ns
$f_{ACNT}$	Maximum internal array clock frequency	(2), (4)	144.9		116.3		87		72.5		MHz

Table 28. EPM7128A Internal Timing Parameters (Part 2 of 2) *Note (1)*

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	
$t_{RD}$	Register delay			1.7		2.1		2.8		3.3	ns
$t_{COMB}$	Combinatorial delay			1.7		2.1		2.8		3.3	ns
$t_{IC}$	Array clock delay			2.4		3.0		4.1		4.9	ns
$t_{EN}$	Register enable time			2.4		3.0		4.1		4.9	ns
$t_{GLOB}$	Global control delay			1.0		1.2		1.7		2.0	ns
$t_{PRE}$	Register preset time			3.1		3.9		5.2		6.2	ns
$t_{CLR}$	Register clear time			3.1		3.9		5.2		6.2	ns
$t_{PIA}$	PIA delay	(2)		0.9		1.1		1.5		1.8	ns
$t_{LPA}$	Low-power adder	(6)		11.0		10.0		10.0		10.0	ns

Table 29. EPM7256A External Timing Parameters *Note (1)*

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	
$t_{PD1}$	Input to non-registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns
$t_{PD2}$	I/O input to non-registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns
$t_{SU}$	Global clock setup time	(2)	3.7		4.6		6.2		7.4		ns
$t_H$	Global clock hold time	(2)	0.0		0.0		0.0		0.0		ns
$t_{FSU}$	Global clock setup time of fast input		2.5		3.0		3.0		3.0		ns
$t_{FH}$	Global clock hold time of fast input		0.0		0.0		0.0		0.0		ns
$t_{CO1}$	Global clock to output delay	C1 = 35 pF	1.0	3.3	1.0	4.2	1.0	5.5	1.0	6.6	ns
$t_{CH}$	Global clock high time		3.0		3.0		4.0		4.0		ns
$t_{CL}$	Global clock low time		3.0		3.0		4.0		4.0		ns
$t_{ASU}$	Array clock setup time	(2)	0.8		1.0		1.4		1.6		ns
$t_{AH}$	Array clock hold time	(2)	1.9		2.7		4.0		5.1		ns
$t_{ACO1}$	Array clock to output delay	C1 = 35 pF (2)	1.0	6.2	1.0	7.8	1.0	10.3	1.0	12.4	ns
$t_{ACH}$	Array clock high time		3.0		3.0		4.0		4.0		ns
$t_{ACL}$	Array clock low time		3.0		3.0		4.0		4.0		ns
$t_{CPPW}$	Minimum pulse width for clear and preset	(3)	3.0		3.0		4.0		4.0		ns
$t_{CNT}$	Minimum global clock period	(2)		6.4		8.0		10.7		12.8	ns
$f_{CNT}$	Maximum internal global clock frequency	(2), (4)	156.3		125.0		93.5		78.1		MHz
$t_{ACNT}$	Minimum array clock period	(2)		6.4		8.0		10.7		12.8	ns
$f_{ACNT}$	Maximum internal array clock frequency	(2), (4)	156.3		125.0		93.5		78.1		MHz

**Table 30. EPM7256A Internal Timing Parameters (Part 2 of 2)** *Note (1)*

Symbol	Parameter	Conditions	Speed Grade								Unit
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	
$t_{COMB}$	Combinatorial delay			1.6		2.0		2.7		3.2	ns
$t_{IC}$	Array clock delay			2.7		3.4		4.5		5.4	ns
$t_{EN}$	Register enable time			2.5		3.1		4.2		5.0	ns
$t_{GLOB}$	Global control delay			1.1		1.4		1.8		2.2	ns
$t_{PRE}$	Register preset time			2.3		2.9		3.8		4.6	ns
$t_{CLR}$	Register clear time			2.3		2.9		3.8		4.6	ns
$t_{PIA}$	PIA delay	(2)		1.3		1.6		2.1		2.6	ns
$t_{LPA}$	Low-power adder	(6)		11.0		10.0		10.0		10.0	ns

**Notes to tables:**

- (1) These values are specified under the recommended operating conditions shown in [Table 14 on page 28](#). See [Figure 12](#) for more information on switching waveforms.
- (2) These values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (3) This minimum pulse width for preset and clear applies for both global clear and array controls. The  $t_{LPA}$  parameter must be added to this minimum width if the clear or reset signal incorporates the  $t_{LAD}$  parameter into the signal path.
- (4) This parameter is measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) Operating conditions:  $V_{CCIO} = 2.5 \pm 0.2$  V for commercial and industrial use.
- (6) The  $t_{LPA}$  parameter must be added to the  $t_{LAD}$ ,  $t_{LAC}$ ,  $t_{IC}$ ,  $t_{EN}$ ,  $t_{SEXP}$ ,  $t_{ACL}$ , and  $t_{CPPW}$  parameters for macrocells running in low-power mode.

## Power Consumption

Supply power (P) versus frequency ( $f_{MAX}$ , in MHz) for MAX 7000A devices is calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

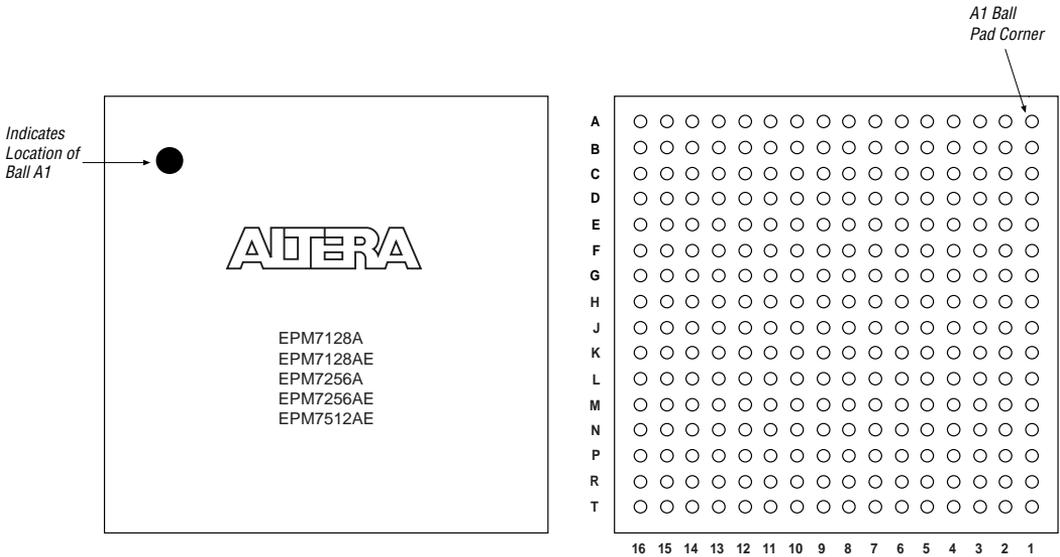
The  $P_{IO}$  value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in [Application Note 74 \(Evaluating Power for Altera Devices\)](#).

The  $I_{CCINT}$  value depends on the switching frequency and the application logic. The  $I_{CCINT}$  value is calculated with the following equation:

$$I_{CCINT} = (A \times MC_{TON}) + [B \times (MC_{DEV} - MC_{TON})] + (C \times MC_{USED} \times f_{MAX} \times \log_{2}LC)$$

Figure 23. 256-Pin FineLine BGA Package Pin-Out Diagram

Package outline not drawn to scale.



## Revision History

The information contained in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.5 supersedes information published in previous versions.

### Version 4.5

The following changes were made in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.5:

- Updated text in the “Power Sequencing & Hot-Socketing” section.

### Version 4.4

The following changes were made in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.4:

- Added Tables 5 through 7.
- Added “Programming Sequence” on page 17 and “Programming Times” on page 18.